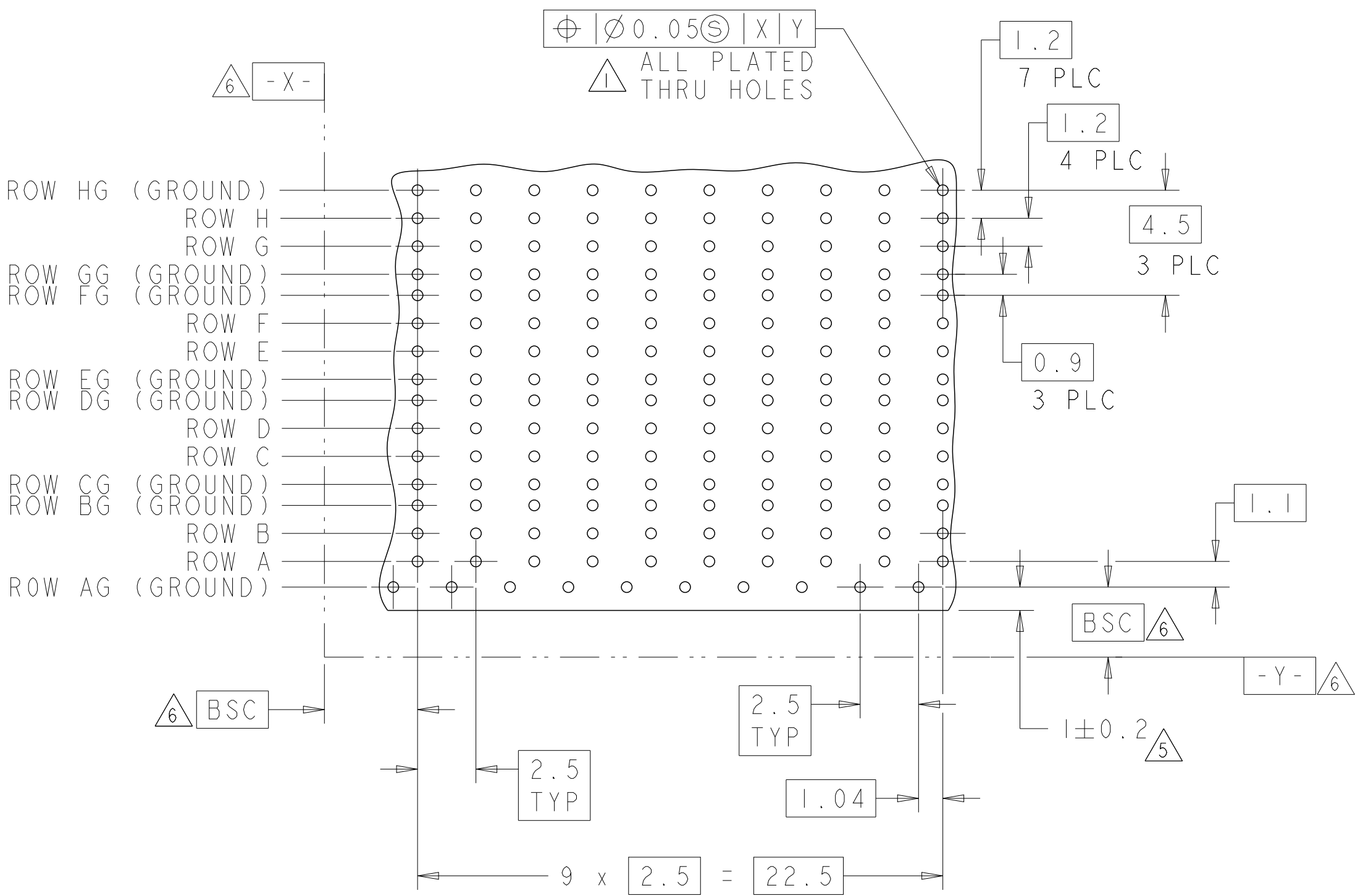
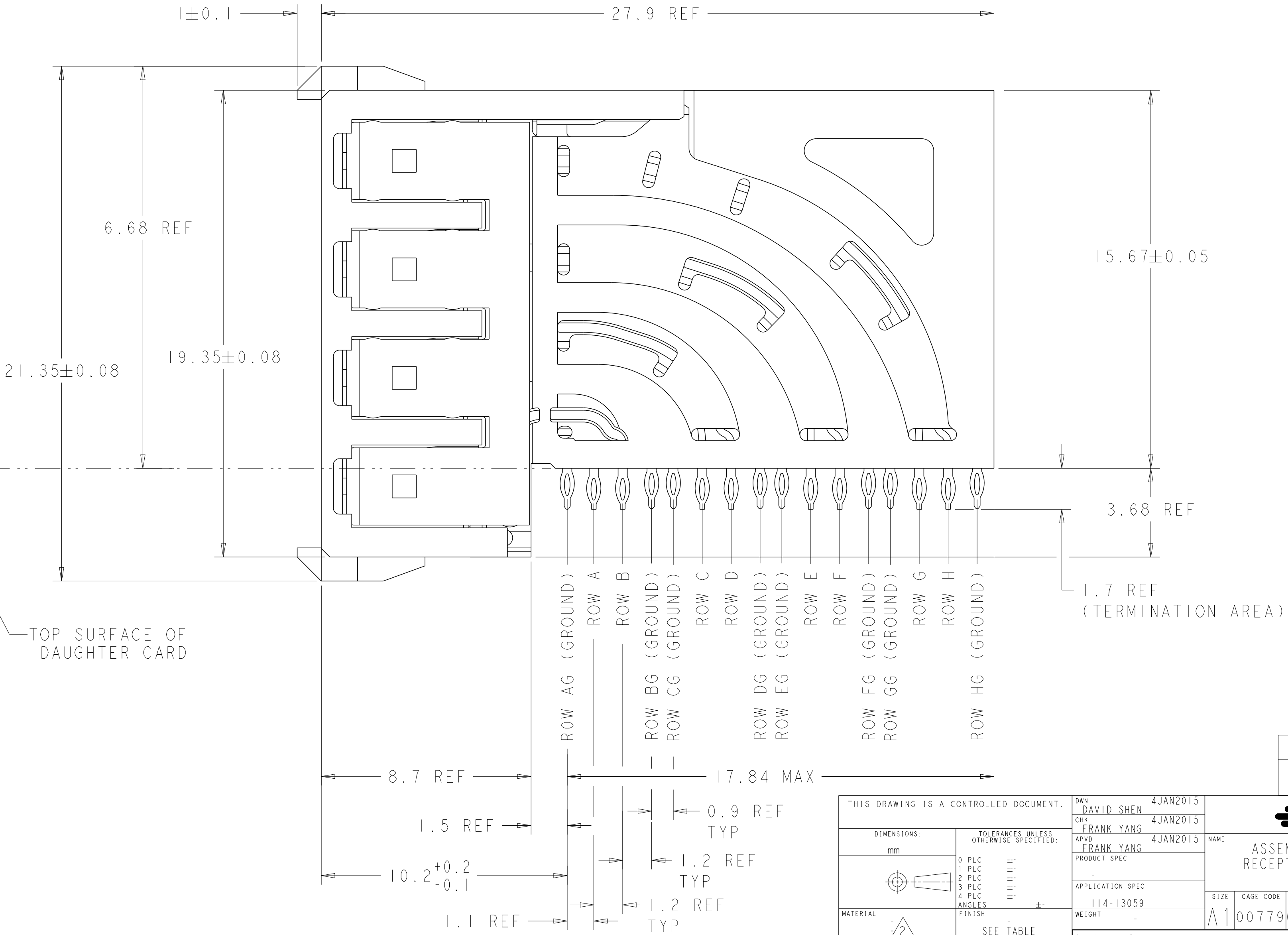
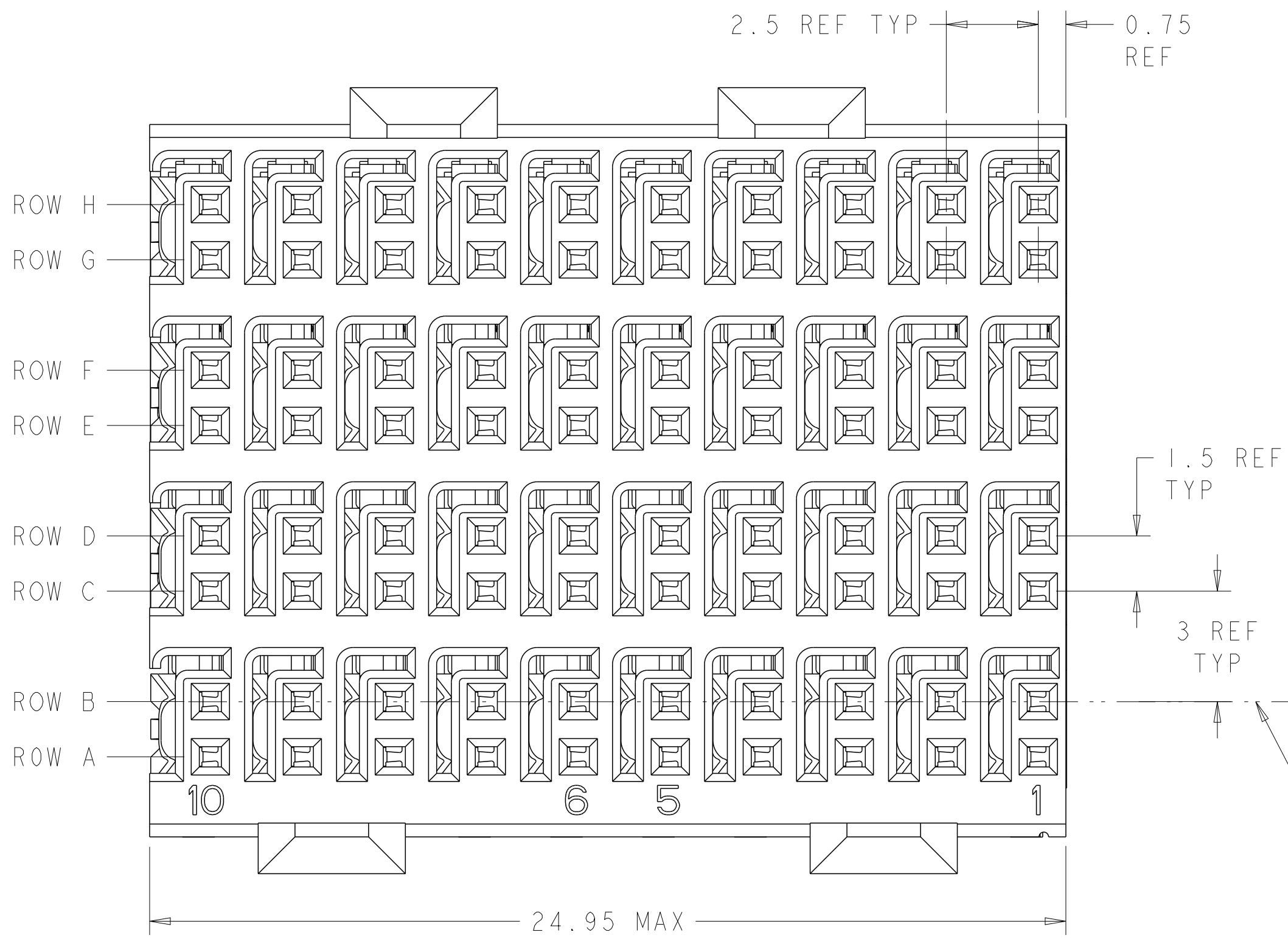



LOC		DIST		REVISIONS				
AD	00	P	LYR	DESCRIPTION	DATE	DWN	APVD	
		A		INITIAL RELEASE	19MAR2015	D.S	F.Y	



RECOMMENDED PC BOARD LAYOUT,
DAUGHTER BOARD,
COMPONENT SIDE SHOWN
SCALE 5:1

- REFERENCE APPLICATION SPEC 114-13059 FOR RECOMMENDED PLATED THRU HOLE DIAMETER AND PLATING THICKNESSES.
- MATERIAL:
SHIELD - PHOSPHOR BRONZE
CONTACT - COPPER-NICKEL-SILICON
HOUSING, CHICKLET AND CHICKLET COVER - GLASS FILLED POLYESTER, UL 94V-O RATED.
- FINISH: CONTACT AND SHIELD
MATING AREA:
MEETS THE PERFORMANCE REQUIREMENTS OF TYCO ELECTRONICS PRODUCT SPECIFICATION, 108-2055-1; BASED ON TELCORDIA GR-1217-CORE, APPLICATIONS IN UNCONTROLLED ENVIRONMENTS.
COMPLIANT PIN AREA:
0.5µm MIN MATTE TIN OVER BASE PLATING.
- CONNECTOR MARKED WITH PART NUMBER AND DATE CODE IN APPROXIMATE AREA SHOWN.
- DIMENSION APPLIES TO CENTERLINE OF THRU HOLE.
- DATUMS AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER.
7. CONTACT AREA LUBRICATED WITH BELLCORE APPROVED LUBRICANT. TECHNICAL REFERENCE: GR-1217-CORE, ISSUE 1, NOVEMBER 1995.



THIS DRAWING IS A CONTROLLED DOCUMENT.				DWN	DAVID SHEN	4JAN2015							
				CHK	FRANK YANG	4JAN2015							
				APVD	FRANK YANG	4JAN2015	 TE Connectivity						
				PRODUCT SPEC		NAME							
				APPLICATION SPEC		ASSEMBLY, Z-Pack HM-eZD+, RECEPTACLE, 4 PAIR, 10 COLUMN							
				114-13059		SIZE		CAGE CODE	DRAWING NO	RESTRICTED TO			
				WEIGHT		A1		00779	©=2170903				
				Customer Drawing				SCALE		SHEET	OF	REV	A